

**REMARKS**

Claims 11-16 are pending. Claim 11 has been amended. Reconsideration and allowance of the present application based on the following remarks are respectfully requested.

Entry of this Amendment is respectfully request since it places the Application in condition for allowance.

Claim 11 was rejected under 35 U.S.C. § 102(e) over Joshi (U.S. Patent No. 6,627,991); and Claim 16 was rejected under 35 U.S.C. § 103(a) over Joshi in view of Takekawa. Applicants have amended claim 11 to clarify that the second leadframe and semiconductor die are located on the same surface of the first leadframe. Accordingly, Applicants respectfully request reconsideration and withdrawal of these rejections.

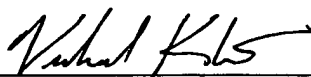
Applicants appreciate the Examiner's indication that claims 12 and 15 are allowable and that claims 13 and 14 contain allowable subject matter. However, in view of the foregoing, Applicants respectfully submit that all of the claims (claims 11-16) are allowable.

Therefore, all objections and rejections having been addressed, it is respectfully submitted that the present application is in a condition for allowance and a Notice to that effect is earnestly solicited.

Should any issues remain unresolved, the Examiner is encouraged to contact the undersigned attorney for Applicants at the telephone number indicated below in order to expeditiously resolve any remaining issues.

Respectfully submitted,

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